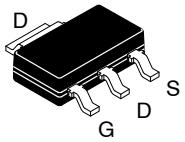
MOSFET – N-Channel, POWERTRENCH®

100 V

FDT3612

V_{DSS}	$R_{DS(ON)}$ MAX	I_D MAX
100 V	120 mΩ @ 10 V	3.7 A
	130 mΩ @ 6 V	



SOT−223
CASE 318H−01

General Description

This N−Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(ON)}$ specifications. The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

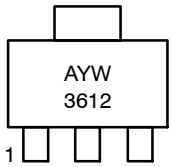
Features

- 3.7 A, 100 V
  - $R_{DS(ON)}$ = 120 mΩ @ V_{GS} = 10 V
  - $R_{DS(ON)}$ = 130 mΩ @ V_{GS} = 6 V
- Fast Switching Speed
- Low Gate Charge (14 nC Typ)
- High Performance Trench Technology for Extremely Low $R_{DS(ON)}$
- High Power and Current Handling Capability in a Widely Used Surface Mount Package.
- This is a Pb−Free Device

Applications

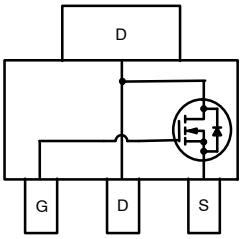
- DC/DC Converter
- Power Management

MARKING DIAGRAM



A = Assembly Location
Y = Year
W = Work Week
3612 = Specific Device Code

PINOUT DIAGRAM



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain−Source Voltage	100	V
V_{GSS}	Gate−Source Voltage	±20	V
I_D	Drain Current − Continuous (Note 1a)	3.7	A
	− Pulsed	20	
P_D	Maximum Power Dissipation (Note 1a)	3.0	W
	(Note 1b)	1.3	
	(Note 1c)	1.1	
T_J, T_{STG}	Operating and Storage Temperature Range	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

Device	Package	Shipping†
FDT3612	SOT−223 (Pb−Free)	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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THERMAL CHARACTERISTICS (T_A = 25°C, unless otherwise noted)

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction−to−Ambient (Note 1a)	42	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction−to−Case (Note 1)	12	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

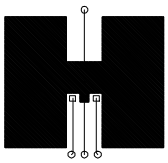
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
DRAIN−SOURCE AVALANCHE RATINGS (Note 2)						
W_{DSS}	Drain−Source Avalanche Energy	Single Pulse, V_{DD} = 50 V, I_D = 3.7 A	–	–	90	mJ
I_{AR}	Drain−Source Avalanche Current		–	–	3.7	A
OFF CHARACTERISTICS						
BV_{DSS}	Drain−Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μA	100	–	–	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	–	106	–	mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 80 V, V_{GS} = 0 V	–	–	10	μA
I_{GSSF}	Gate−Body Leakage, Forward	V_{GS} = 20 V, V_{DS} = 0 V	–	–	100	nA
I_{GSSR}	Gate−Body Leakage, Reverse	V_{GS} = −20 V, V_{DS} = 0 V	–	–	−100	nA
ON CHARACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 μA	2	2.5	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	–	−6	–	mV/°C
$R_{DS(ON)}$	Static Drain−Source On−Resistance	V_{GS} = 10 V, I_D = 3.7 A	–	88	120	mΩ
		V_{GS} = 6 V, I_D = 3.5 A	–	94	130	
		V_{GS} = 10 V, I_D = 3.7 A, T_J = 125°C	–	170	245	
$I_{D(ON)}$	On−State Drain Current	V_{GS} = 10 V, V_{DS} = 10 V	10	–	–	A
g_{FS}	Forward Transconductance	V_{DS} = 10 V, I_D = 3.7 A	–	11	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 50 V, V_{GS} = 0 V, f = 1.0 MHz	–	632	–	pF
C_{oss}	Output Capacitance		–	40	–	pF
C_{rss}	Reverse Transfer Capacitance		–	20	–	pF
SWITCHING CHARACTERISTICS (Note 2)						
$t_{d(on)}$	Turn − On Delay Time	V_{DD} = 50 V, I_D = 1 A, V_{GS} = 10 V, R_{GEN} = 6 Ω	–	8.5	17	ns
t_r	Turn − On Rise Time		–	2	4	ns
$t_{d(off)}$	Turn − Off Delay Time		–	23	37	ns
t_f	Turn − Off Fall Time		–	4.5	9	ns
Q_g	Total Gate Charge	V_{DS} = 50 V, I_D = 3.7 A, V_{GS} = 10 V	–	14	20	nC
Q_{gs}	Gate−Source Charge		–	2.4	–	nC
Q_{gd}	Gate−Drain Charge		–	3.8	–	nC
DRAIN−SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_S	Maximum Continuous Drain−Source Diode Forward Current		–	–	2.5	A
V_{SD}	Drain−Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 2.5 A (Note 2)	–	0.75	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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NOTES:

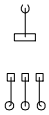
1. $R_{\theta JA}$ is the sum of the junction−to−case and case−to−ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 42°C/W when mounted on a 1 in^2 pad of 2 oz copper.



b. 95°C/W when mounted on a 0.0066 in^2 pad of 2 oz copper.



c. 110°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%.

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TYPICAL CHARACTERISTICS

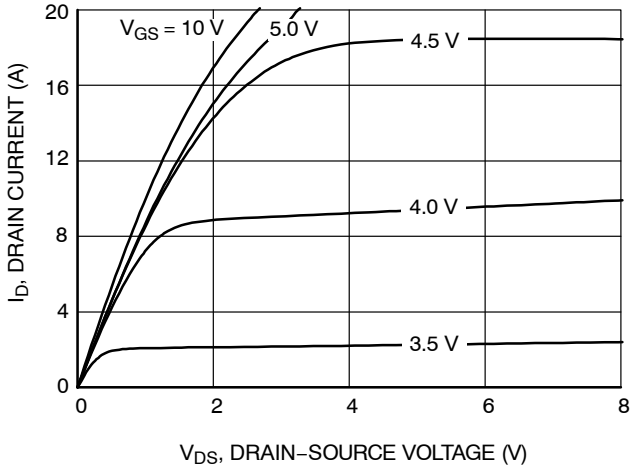


Figure 1. On−Region Characteristics

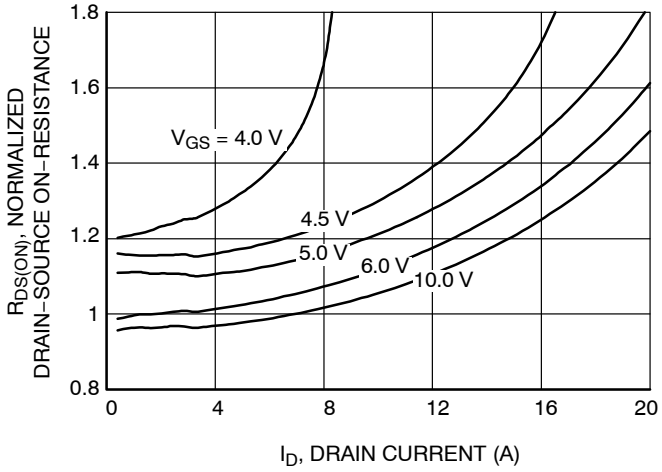


Figure 2. On−Resistance Variation with Drain Current and Gate Voltage

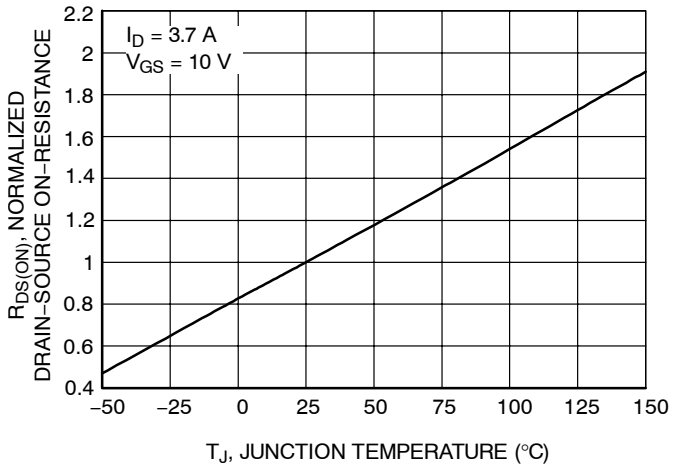


Figure 3. On−Resistance Variation with Temperature

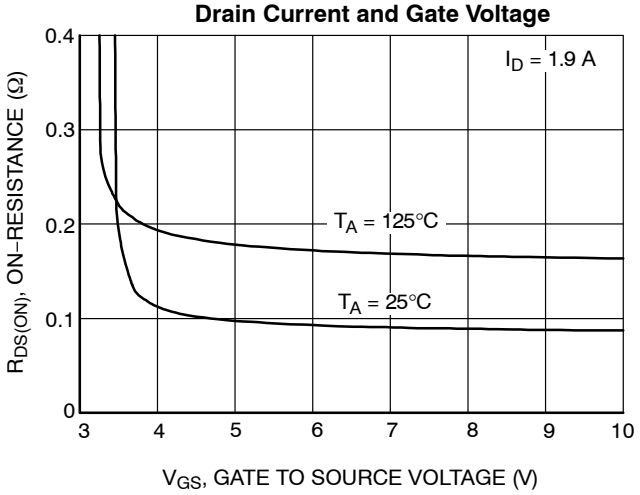


Figure 4. On−Resistance Variation with Gate−to−Source Voltage

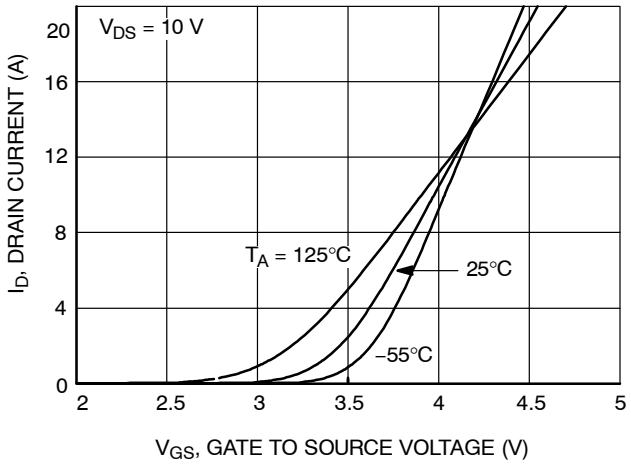


Figure 5. Transfer Characteristics

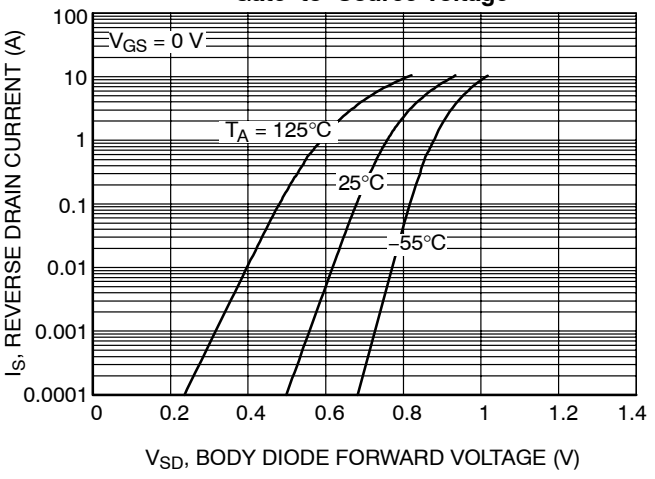


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

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TYPICAL CHARACTERISTICS (continued)

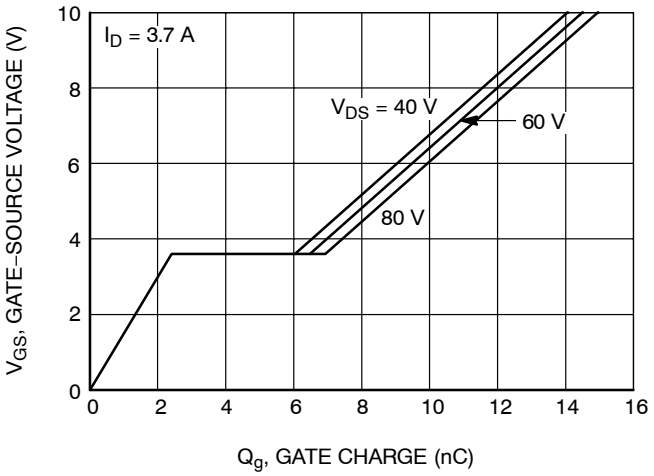


Figure 7. Gate Charge Characteristics

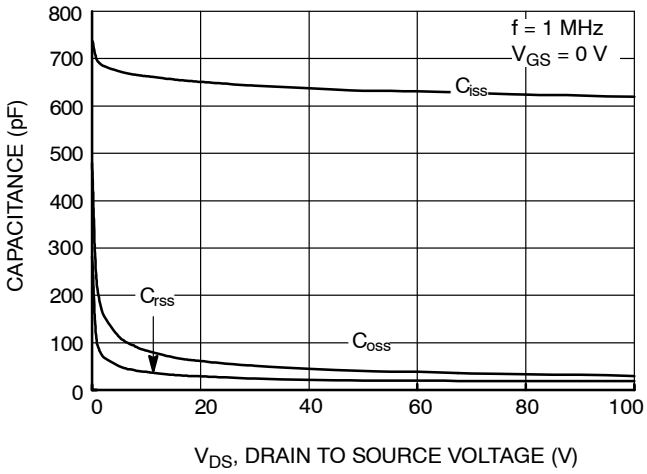


Figure 8. Capacitance Characteristics

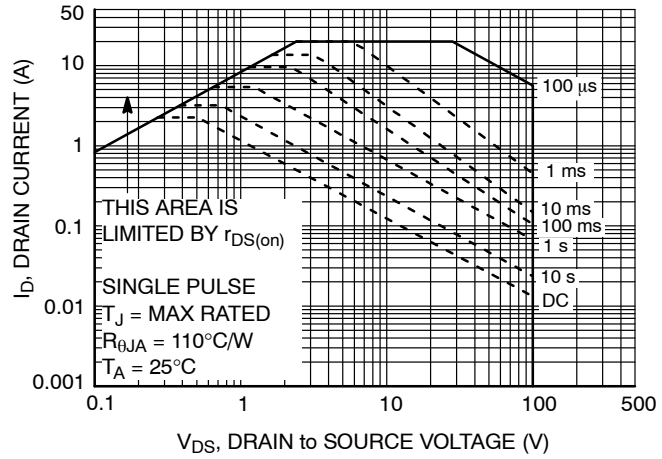


Figure 9. Maximum Safe Operating Area

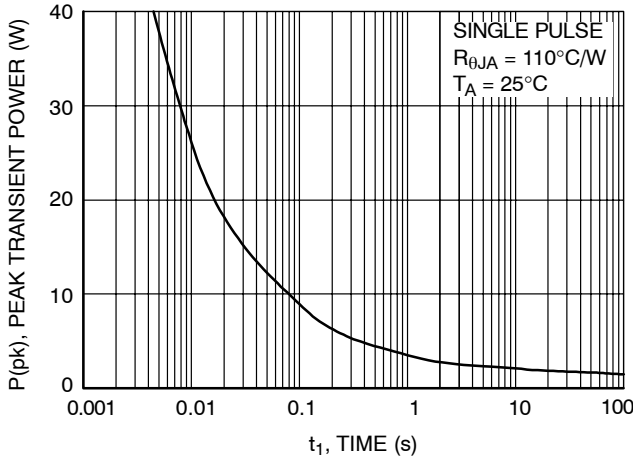


Figure 10. Single Pulse Maximum Power Dissipation

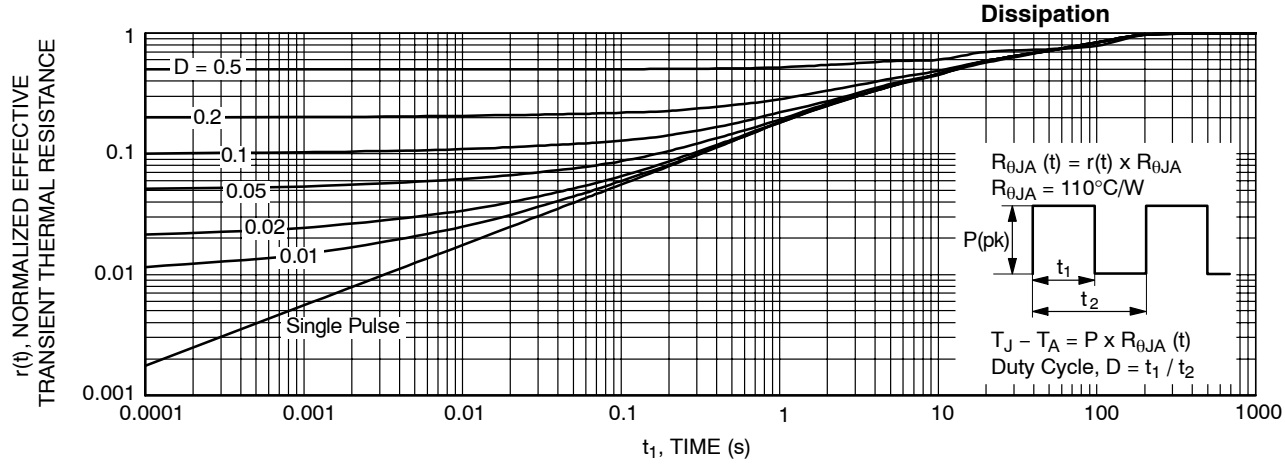
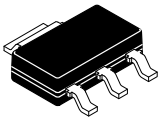


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1c.
Transient thermal response will change depending on the circuit board design.

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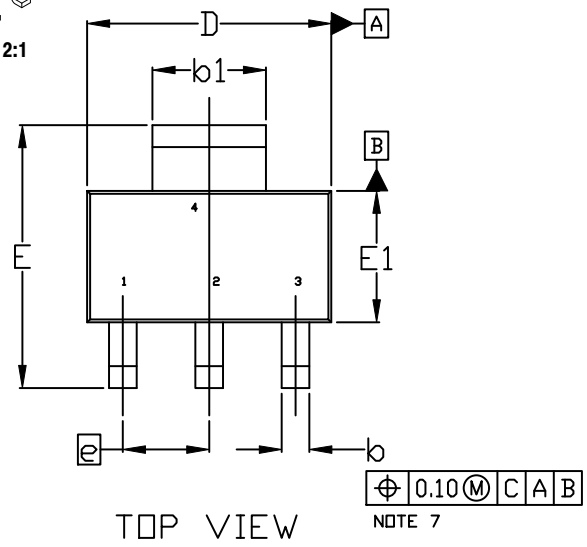
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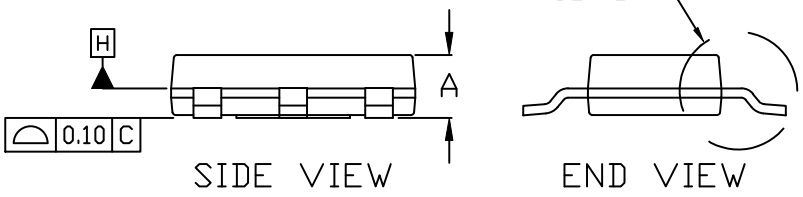


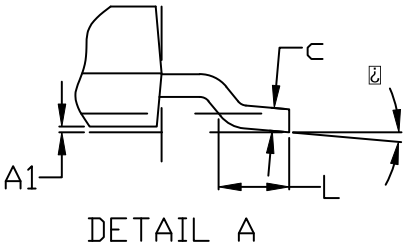
SCALE 2:1

SOT−223
CASE 318H
ISSUE B

DATE 13 MAY 2020

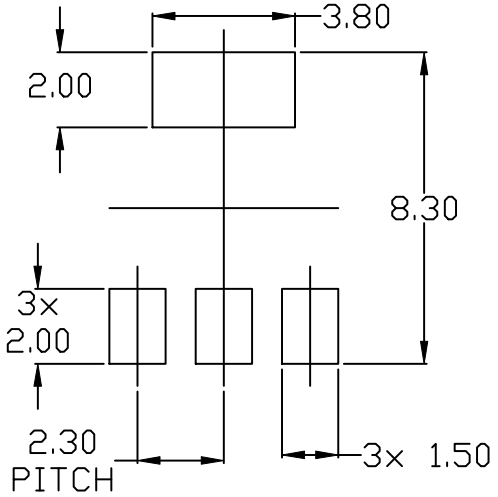






NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E1 ARE DETERMINED AT DATUM H. DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. SHALL NOT EXCEED 0.23mm PER SIDE.
4. LEAD DIMENSIONS b AND b1 DO NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBBAR PROTRUSION IS 0.08mm PER SIDE.
5. DATUMS A AND B ARE DETERMINED AT DATUM H.
6. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
7. POSITIONAL TOLERANCE APPLIES TO DIMENSIONS b AND b1.

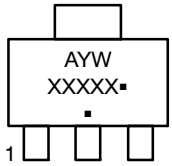
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	---	---	1.80
A1	0.02	0.06	0.11
b	0.60	0.74	0.88
b1	2.90	3.00	3.10
c	0.24	---	0.35
D	6.30	6.50	6.70
E	6.70	7.00	7.30
E1	3.30	3.50	3.70
e	2.30 BSC		
L	0.25	---	---
θ	0°	---	10°



RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



A = Assembly Location
Y = Year
W = Work Week
XXXXX = Specific Device Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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